

**11NM60Z**

Preliminary

Power MOSFET

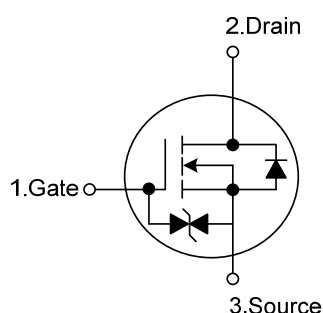
**11A, 600V N-CHANNEL
SUPER-JUNCTION MOSFET****DESCRIPTION**

The UTC **11NM60Z** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

FEATURES

* $R_{DS(ON)} \leq 0.32 \Omega$ @ $V_{GS}=10V$, $I_D=5.5A$

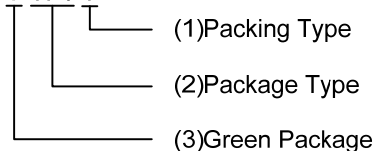
* High Switching Speed

SYMBOL**ORDERING INFORMATION**

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
11NM60ZL-TF1-T	11NM60ZG-TF1-T	TO-220F1	G	D	S	Tube
11NM60ZL-TF2-T	11NM60ZG-TF2-T	TO-220F2	G	D	S	Tube
11NM60ZL-TW1-T	11NM60ZG-TW1-T	TO-220WF	G	D	S	Tube
11NM60ZL-TN3-R	11NM60ZG-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

11NM60ZG-TF1-T

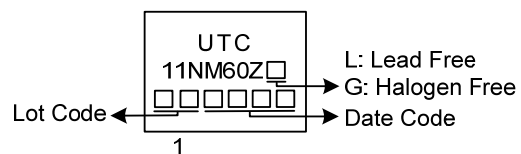


(1) T: Tube, R: Tape Reel

(2) TF1: TO-220F1, TF2: TO-220F2, TW1: TO-220WF
TN3: TO-252

(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** ($T_C=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current	Continuous	I_D	11	A
	Pulsed (Note 2)	I_{DM}	33	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	288	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.8	V/ns
Power Dissipation	TO-220F1/TO-220F2	P_D	29	W
	TO-220WF			
	TO-252		59	W
Junction Temperature		T_J	+150	$^{\circ}\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^{\circ}\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. $L = 100\text{mH}$, $I_{AS} = 2.4\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\ \Omega$ Starting $T_J = 25^{\circ}\text{C}$

4. $I_{SD} \leq 11\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}\text{C}$

■ **THERMAL DATA**

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220F1/TO-220F2	θ_{JA}	62.5	$^{\circ}\text{C}/\text{W}$
	TO-220WF			
	TO-252		110	$^{\circ}\text{C}/\text{W}$
Junction to Case	TO-220F1/TO-220F2	θ_{JC}	4.3	$^{\circ}\text{C}/\text{W}$
	TO-220WF			
	TO-252		2.1 (Note)	$^{\circ}\text{C}/\text{W}$

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

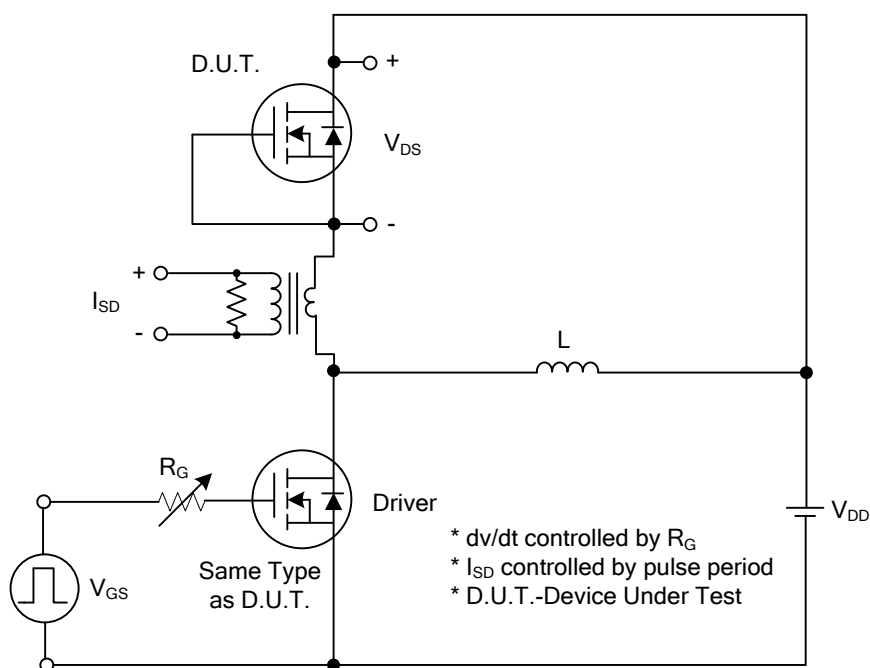
■ **ELECTRICAL CHARACTERISTICS** ($T_J=25^{\circ}\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D = 250μA	600			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA
Gate-Source Leakage Current	Forward	I _{GSS}	V _{GS} =20V, V _{DS} =0V			10	μA
	Reverse		V _{GS} =-20V, V _{DS} =0V			-10	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =5.5A			0.32	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =50V, f=1.0 MHz		742		pF
Output Capacitance		C _{OSS}			94		pF
Reverse Transfer Capacitance		C _{RSS}			6		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q _G	V _{DS} =480V, V _{GS} =10V, I _D =11A (Note 1, 2)		29		nC
Gateource Charge		Q _{GS}			5.2		nC
Gate-Drain Charge		Q _{GD}			10		nC
Turn-on Delay Time (Note 1)		t _{D(ON)}	V _{DS} =100V, V _{GS} =10V, I _D =11A, R _G =25Ω (Note 1, 2)		10		ns
Rise Time		t _R			24		ns
Turn-off Delay Time		t _{D(OFF)}			120		ns
Fall-Time		t _F			70		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I _S				11	A
Maximum Body-Diode Pulsed Current		I _{SM}				33	A
Drain-Source Diode Forward Voltage (Note 1)		V _{SD}	I _S =11A, V _{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)		t _{rr}	I _S =11A, V _{GS} =0V		328		ns
Reverse Recovery Charge		Q _{rr}	dl _F /dt=100A/μs (Note1)		3.8		μC

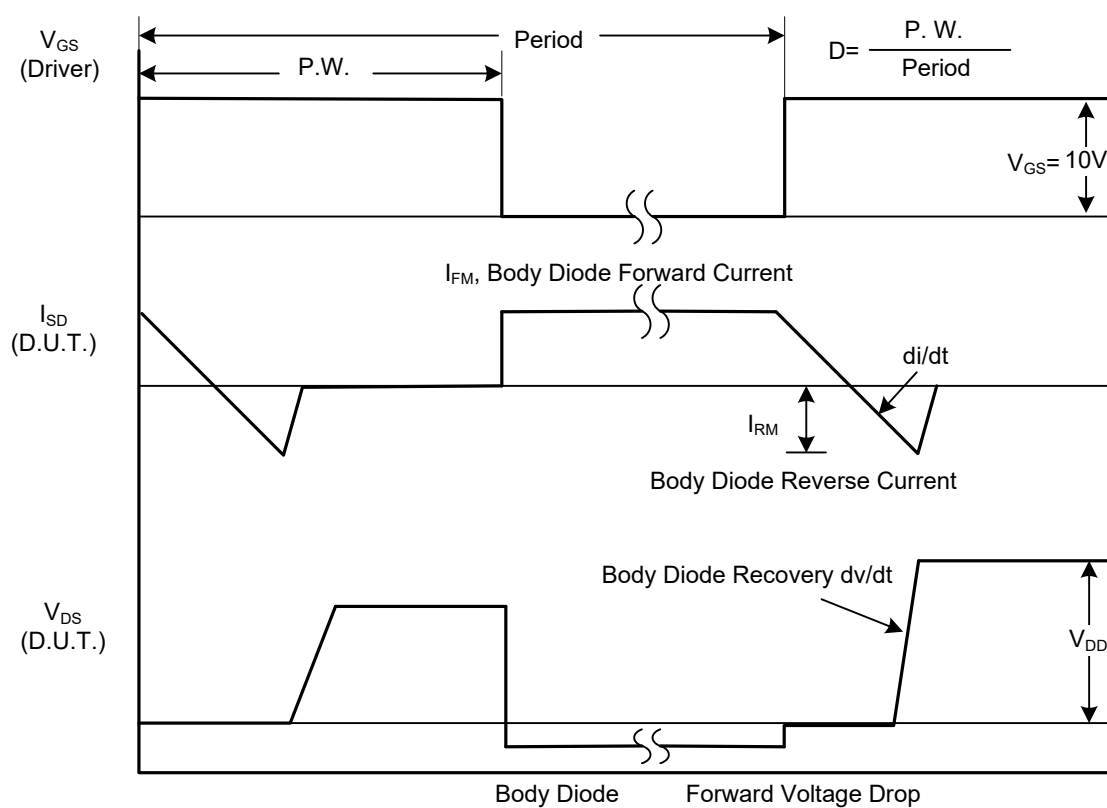
Notes: 1. Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

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